

Features

- High infrared radiant intensity
- Peak emission wavelength of 1340 nm
- Compact surface-mount package
- High reliability and stable optical performance
- Compatible with automated placement and reflow soldering processes

Applications

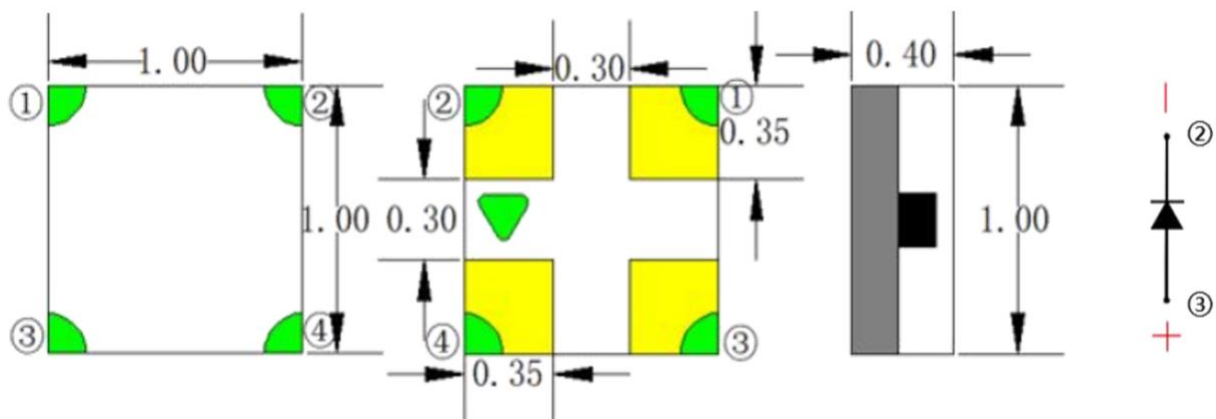
- Infrared sensing systems
- Optical detection modules
- Industrial automation sensors
- Optical measurement equipment
- Infrared communication systems

Description

The IN-S11TZTKUSWIR.1340 is a short-wave infrared emitting diode designed to provide high radiant output with a peak emission wavelength of 1340 nm.

The device is packaged in a compact surface-mount package suitable for automated assembly processes. It delivers stable optical performance and high reliability, making it suitable for a wide range of infrared sensing and detection applications

Package Dimensions in mm



Notes

1. All dimensions are in millimeters.
2. Tolerance is ± 0.1 mm unless otherwise noted

Absolute Maximum Rating $T_A=25^{\circ}\text{C}$

| Parameter | Symbol | Ratings | Unit |
|-------------------------|------------------|---------|------|
| Power Dissipation | Pd | 100 | mW |
| Reverse Voltage | V _R | 5 | V |
| Forward Current | I _F | ≤50 | mA |
| Peak Forward Current*1 | I _{FP} | 100 | mA |
| Operating Temperature | T _{opr} | -40~+85 | °C |
| Storage Temperature | T _{stg} | -40~+85 | °C |
| Soldering Temperature*2 | T _{sol} | 245 | °C |

Notes

1. Pulse width ≤ 100μs, Duty cycle = 10%.
2. 2mm from body for 5 seconds.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electro-Optical Characteristics $T_A=25^{\circ}\text{C}$

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|---------------------|-----------------|-------------------|------|------|------|---------------|
| Luminous intensity | I_e | $I_F=20\text{mA}$ | -- | 1.6 | -- | mW/sr |
| Peak Wavelength | λ_p | $I_F=20\text{mA}$ | -- | 1340 | -- | nm |
| Dominant Wavelength | λ_d | $I_F=20\text{mA}$ | 1300 | -- | 1400 | nm |
| Forward Voltage | V_F | $I_F=20\text{mA}$ | 0.5 | -- | 1.8 | V |
| Reverse Current | I_R | $V_R=5\text{V}$ | -- | -- | 10 | μA |
| View Angle | $2\theta_{1/2}$ | $I_F=20\text{mA}$ | -- | 120 | -- | deg |

Revision History

| Changes since last revision | Page | Version No. | Revision Date |
|-----------------------------|------|-------------|---------------|
| Preliminary version | | 0.1 | 03-11-2026 |
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